

2823



SCHIFF HARDIN & WAITE

PATENT DEPARTMENT  
6600 SEARS TOWER  
233 SOUTH WACKER DRIVE  
CHICAGO, ILLINOIS 60606

In re Application of: Schwalke et al

Serial No.: 09/462,994

GROUP ART UNIT: 2823

Filed: January 14, 2000

EXAMINER: B. Kebede

For: "INTEGRATED CIRCUIT ARRANGEMENT  
AND METHOD FOR THE MANUFACTURE THEREOF"

CONFIRMATION NO.: 5747

AMENDMENT D

RECEIVED  
FEB - 7 2003  
TECHNOLOGY CENTER 2800

Assistant Commissioner for Patents  
Washington D.C. 20231

SIR:

Transmitted herewith is an amendment in the above-identified application.

☒ No additional fee is required.

The fee has been calculated as shown below.

CLAIMS AS AMENDED						
	(2) CLAIMS REMAINING AFTER AMENDMENT		(4) HIGHEST NO. PREVIOUSLY PAID FOR	(5) PRESENT EXTRA	(6) RATE	(7) ADDITIONAL FEE
TOTAL CLAIMS	*11	MINUS	**20	X	( ) X 9.00 ( ) X 18.00	
INDEP. CLAIMS	*2	MINUS	3	X	( ) X 42.00 ( ) X 84.00	
Application amended to contain any multiple dependent claims not previously paid for.				( ) YES ( ) NO	( ) \$140.00 ( ) \$280.00 ONE TIME	
				TOTAL ADDITIONAL FEE FOR THIS AMENDMENT		\$0.00

\* If the entry in Column 2 is less than the entry in Column 4, write "0" in Column 5.

\*\* If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20 write "20" in this space.

- ☐ Applicants petition the Commissioner of Patents and Trademarks to extend this time for response to the Office Action dated \_\_\_\_ for \_\_\_\_ months so that the period for response is extended to \_\_\_\_\_. A check in the amount of \$\_\_\_\_\_ is attached to cover the cost of the extension. Any deficiency or overpayment should be charged or credited to deposit account No. 501519. A duplicate copy of this sheet is enclosed.
  - ☐ A check in the amount of \$ \_\_\_\_\_ is attached.
  - ☐ A check for \$ \_\_\_\_\_ accompanying IDS under 37 CFR 1.97(c) is attached
  - ☐ A check for \$ \_\_\_\_\_ and Petition for Consideration of IDS under 37 CFR 1.97(d) is attached.
  - ☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or to credit any overpayment to account No. 501519. A duplicate of this sheet is enclosed.
- When phoning re this application, please call (312) 258-5779.

SCHIFF HARDIN & WAITE (Customer Number: 26574)

Patent Department

BY Mark Bergner (45,877)

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on January 28, 2003.

Mark Bergner  
NAME OF APPLICANT'S ATTORNEY  
Mark Bergner  
SIGNATURE  
January 28, 2003  
DATE



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✓ Short

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
AMENDMENT D

APPLICANT: Schwalke, et al. DOCKET NO: P99,2666  
SERIAL NO.: 09/462,994 ART UNIT: 2823  
FILED: January 14, 2000 EXAMINER: B. Kebede  
TITLE: Integrated Circuit Arrangement and Method for the Manufacture  
Thereof

5 Assistant Commissioner for Patents,  
Washington, D.C. 20231

Dear Sir:

This amendment is responsive to the non-final Office Action dated October  
29, 2002 ("OA").

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IN THE CLAIMS

Please amend claim 11 according to the following replacement claim,  
referring to Appendix A for the claim mark-ups.

11. (Amended) An integrated circuit arrangement comprising:  
a semiconductor substrate having at least one doped region; and  
a plane arranged on a surface of said semiconductor substrate and having a  
number of conductive useful structures and at least one conductive  
filler structure, said conductive filler structure being conductively  
connected to said doped region.

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